

Docket No. 511.40488R01
Serial No. 10/771,260
December 15, 2005

IN THE CLAIMS:

Please cancel claims 2, 3, 5-7, 11 and 12 without prejudice or disclaimer, and amend the claims remaining in the application as follows:

1. (Twice amended) A prepreg which comprises a substrate and a resin composition containing a resin, an inorganic filler in an amount of 25% by volume or more based on the total volume of a solid component of the resin composition and a silicone polymer, which resin composition being impregnated into the substrate, wherein the inorganic filler has previously been subjected to surface treatment by a silicone polymer.

Please add the following new claims to the application:

29. The prepreg according to claim 1, wherein said resin is at least one selected from the group consisting of epoxy resin, polyimide resin, melamine resin, and triazine resin.

30. The prepreg according to claim 1, wherein said inorganic filler is made of at least one material selected from the group consisting of calcium carbonate, alumina, titanium oxide, mica, aluminum carbonate, aluminum hydroxide, magnesium silicate, aluminum silicate, calcined clay, talc, silica, glass short fiber, aluminum borate whisker and silicon carbide whisker.

31. The prepreg according to claim 1, wherein a varnish of said resin composition has been impregnated into said substrate, and said varnish has a solids content within a range of 50 to 80% by weight.